

Common mode filters High-speed differential signal line (USB2.0, LVDS, etc.) **TCM-G series**









TCM1608G type













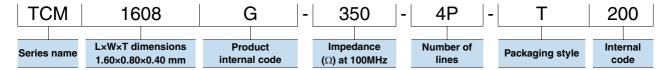
FEATURES

- O Thin-film common mode filter based on the thin-film processing techniques and material technology cultivated from HDD head manufacturing
- O Has EMC suppression by achieving wide frequency range (cutoff frequency of 3GHz or higher) differential mode transmission while ensuring common mode impedance with virtually no affect on the high-speed differential transmission line signal.
- \bigcirc This is 1608 (1.60 \times 0.80 \times 0.40mm) array type.
- Operating temperature range: -25 to +85°C

APPLICATION

- O Noise countermeasure for high-speed differential interfaces (USB2.0, LVDS, MIPI, etc.) for mobile devices and general consumer products such as smart phones, tablets, digital cameras, and portable music players.
- O Application guides: Smart phones/tablets

PART NUMBER CONSTRUCTION



CHARACTERISTICS SPECIFICATION TABLE

Common mode impedance		DC resistance	Rated current	Rated voltage	Insulation resistance	Part No.
[at 100MHz]		[1 line]				
(Ω)	Tolerance	(Ω)	(A)max.	(V)max.	(M Ω)min.	
35	±30%	0.85±30%	0.10	5	10	TCM1608G-350-4P-T200
65	±20%	1.30±30%	0.10	5	10	TCM1608G-650-4P-T200
90	±20%	1.50±30%	0.10	5	10	TCM1608G-900-4P-T200
200	±20%	4.00±30%	0.05	5	10	TCM1608G-201-4P-T200

Background yellow: The product which is not recommended to a new design.

Measurement equipment

Measurement item	Product No.	Manufacturer
Common mode impedance	4291A	Keysight Technologies
DC resistance	4338A	Keysight Technologies
Insulation resistance	4339A	Keysight Technologies

^{*} Equivalent measurement equipment may be used.

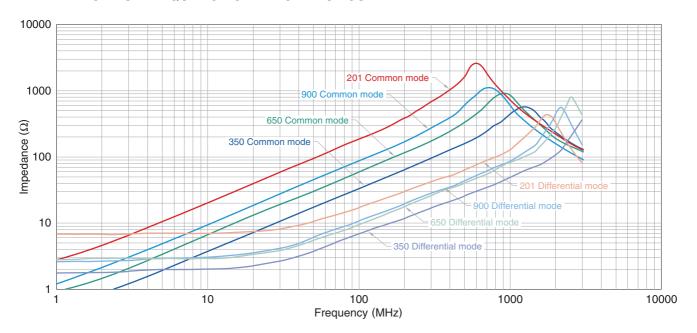






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■IMPEDANCE VS. FREQUENCY CHARACTERISTICS

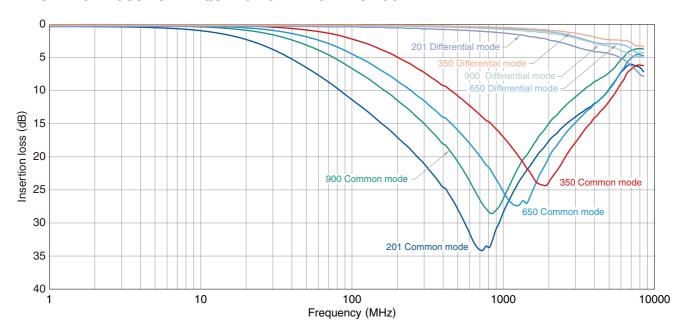


Measurement equipment

Product No.	Manufacturer
E4991A	Keysight Technologies

^{*} Equivalent measurement equipment may be used.

INSERTION LOSS VS. FREQUENCY CHARACTERISTICS



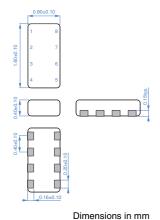
Measurement equipment

Product No.	Manufacturer
E5071B	Keysight Technologies

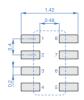
^{*} Equivalent measurement equipment may be used.

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■SHAPE & DIMENSIONS

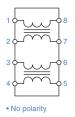


■ RECOMMENDED LAND PATTERN

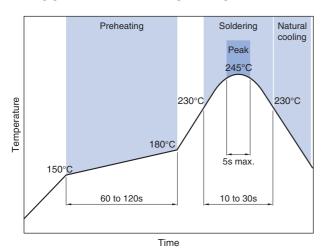


Dimensions in mm

CIRCUIT DIAGRAM

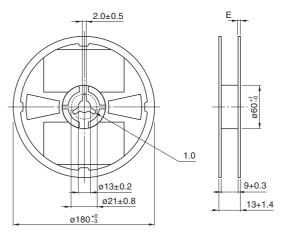


■ RECOMMENDED REFLOW PROFILE



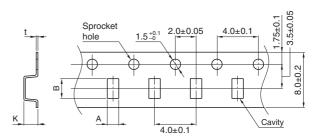
■PACKAGING STYLE

REEL DIMENSIONS



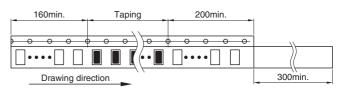
Dimensions in mm

TAPE DIMENSIONS



Dimensions in mm

Туре	Α	В	K
TCM1608G	1.00	1.80	0.50



Dimensions in mm

□PACKAGE QUANTITY

Package quantity	4,000 pcs/reel

TEMPERATURE RANGE, INDIVIDUAL WEIGHT

Operating temperature range	Storage temperature range*	Individual weight
−25 to +85 °C	−25 to +85 °C	4.0 mg

^{*} The storage temperature range is for after the assembly.

REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using this products.

⚠ REMINDERS	
 The storage period is less than 6 months. Be sure to follow the storage conditions (temperature: 5 to 40°C, humidity: 20 to less). If the storage period elapses, the soldering of the terminal electrodes may deteriorate. 	70% RH or
On not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).	
 Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and chip to does not exceed 150°C. 	emperature
 Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur. 	
When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.	chip due to
 Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the design. 	set thermal
 Carefully lay out the coil for the circuit board design of the non-magnetic shield type. A malfunction may occur due to magnetic interference. 	
Use a wrist band to discharge static electricity in your body through the grounding wire.	
On not expose the products to magnets or magnetic fields.	
On not use for a purpose outside of the contents regulated in the delivery specifications.	
The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommunicat ment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measuren ment, industrial robots) under a normal operation and use condition. The products are not designed or warranted to meet the requirements of the applications listed below, whose performance a ity require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage.	nent equip- and/or qual-

- (1) Aerospace/aviation equipment
- (2) Transportation equipment (cars, electric trains, ships, etc.)
- (3) Medical equipment

person or property.

(4) Power-generation control equipment

set forth in the each catalog, please contact us.

- (5) Atomic energy-related equipment
- (6) Seabed equipment
- (7) Transportation control equipment

- (8) Public information-processing equipment
- (9) Military equipment
- (10) Electric heating apparatus, burning equipment
- (11) Disaster prevention/crime prevention equipment
- (12) Safety equipment
- (13) Other applications that are not considered general-purpose applications

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.

If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions